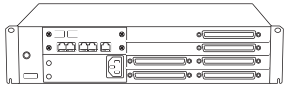




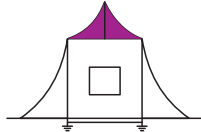
RJ11

RJ11 小封装、高速贴片防护方案

Small encapsulation and high speed SMD protecting solutions of RJ11



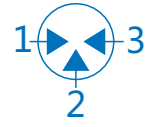
PSTN



LPZO_B-2



B3A420

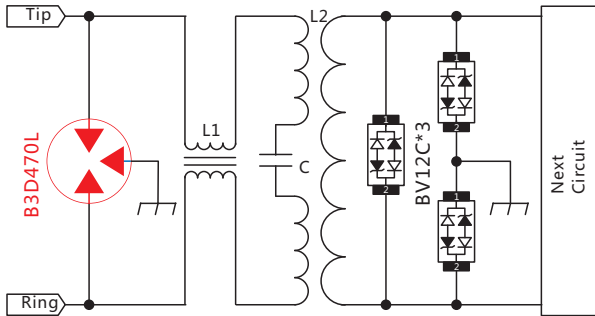


Pin1&Pin3 to Pin2

$I_{pp} \geq 2KA @ 8/20\mu s$ $V_{BR} \geq 360V$

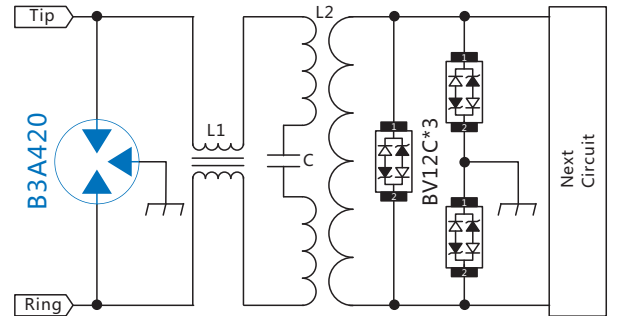
行业传统方案

Industrial traditional solutions



槟城创新方案

Bencent's innovative solutions



DC Breakdown Voltage(V_{BR}) 100V/s (V)	Tolerance of V_{BR} (V)	Impulse Spark-over Voltage 1KV/ μs (V)	Arc Voltage (V_a) (V)@1A	Impulse Discharge Current 8/20 μs (KA)	Insulation Resistance@DC (G Ω) (V)	Capacitance Co(pF) 0.5VDC@1MHz	Size L*W*H (mm)
470	360-560	≤ 950	≥ 10	2	≥ 1 100	≤ 1.0	4.2x2.7x3.9



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